

B
Bh



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Issue Patent Application of:

Allen RITTER

Application Serial No.: 10/063,985 ✓

Filed: May 31, 2002

For: HEAT SINK ASSEMBLY

)
)
)
)
)
)

Group Art Unit: 3753

Examiner: A. FLANIGAN

COMMUNICATION TO EXAMINER

MAIL STOP: ISSUE FEE

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Sir:

Further to a telephone conference with Examiner Flanigan on September 17, 2004 Applicant notes that the form PTO-1449, which was filed by Applicant on September 5, 2002 and sent to the Applicant with the Office Action mailed December 11, 2003 did not reflect consideration by the Examiner of the two items listed under "other materials" We attach a copy of such PTO-1449.

Applicant requests the Examiner to initial such items and return the fully initialed PTO-1449 to Applicant. Should the Examiner have any questions regarding this Communication, the Examiner is invited to contact Applicant's undersigned representative at the telephone number listed below.

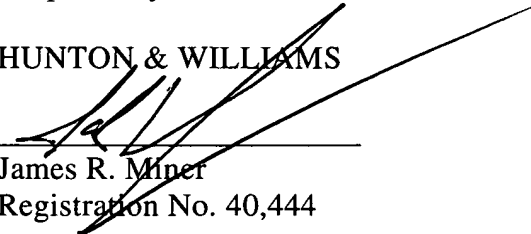
Applicant believes that no fees are due in connection with this filing. However, for any fees due the Commissioner is hereby authorized to charge the undersigned's Deposit Account No. 50-0206.

Respectfully submitted,

HUNTON & WILLIAMS

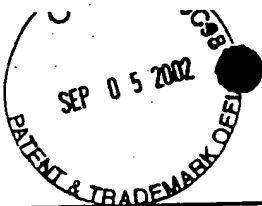
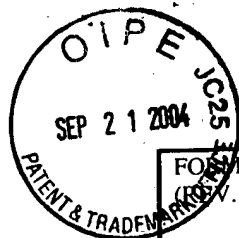
Dated: September 21, 2004

By:


James R. Miner

Registration No. 40,444

Hunton & Williams LLP
1900 K Street, N.W., Suite 1200
Washington, D.C. 20006-1109
(202) 955-1500 (Telephone)
(202) 778-2201 (Facsimile)



Attorney Docket No. 57761.000108
Serial Number: 10/063,985

Page 1 of 1

| | | | | | | | | | | | | | |
|---|---|---|---|---|---|---------------------------|---|---|-----------------|-----------------------|-------|--------------|---------------------------|
| FORM PTO-1449 (Rev. 7-80) | | U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE | | ATTY. DOCKET NO.: 57761.000108 | | SERIAL NO.: 10/063,985 | | | | | | | |
| LIST OF MATERIALS CITED BY APPLICANT (Use several sheets if necessary) | | | | INVENTOR'S NAME: Allen M. Ritter, et al. | | EXAMINER: Unassigned | | | | | | | |
| | | | | FILING DATE: May 31, 2002 | | GROUP 3743 | | | | | | | |
| U.S. PATENT DOCUMENTS | | | | | | | | | | | | | |
| *EXAMINER INITIAL | | DOCUMENT NUMBER | | | | | | | DATE | NAME | CLASS | SUB CLASS | FILING DATE |
| A B C D E F G H I J K L M N O | A | 6 | 0 | 1 | 8 | 4 | 5 | 9 | 01/25/00 | Carlson, et al. | | | |
| | B | 6 | 1 | 3 | 1 | 6 | 4 | 4 | 10/17/00 | Kohara, et al. | | | |
| | C | 6 | 1 | 3 | 1 | 6 | 5 | 0 | 10/17/00 | North et al. | | | |
| | D | 5 | 9 | 8 | 7 | 8 | 9 | 3 | 11/23/99 | Schulz-Harder, et al. | | | |
| | E | 6 | 0 | 1 | 4 | 3 | 1 | 2 | 01/11/00 | Schulz-Harder et al. | | | |
| | F | 5 | 8 | 4 | 1 | 6 | 3 | 4 | 11/24/98 | Visser | | | |
| | G | 5 | 2 | 0 | 5 | 3 | 5 | 3 | 04/27/93 | Willemsen, et al. | | | |
| | H | | | | | | | | | | | | |
| | I | | | | | | | | | | | | |
| | J | | | | | | | | | | | | |
| | K | | | | | | | | | | | | |
| | L | | | | | | | | | | | | |
| | M | | | | | | | | | | | | |
| | N | | | | | | | | | | | | |
| | O | | | | | | | | | | | | |
| FOREIGN PATENT DOCUMENTS | | | | | | | | | | | | | |
| | | DOCUMENT NUMBER | | | | | | | DATE | COUNTRY | CLASS | SUB CLASS | TRANS LATION YES NO |
| | | | | | | | | | | | | | |
| OTHER MATERIALS (Including Author, Title, Date, Pertinent Pages, Etc.) | | | | | | | | | | | | | |
| | | "Fluid-Cooled DBC Substrates," by J. Schulz-Harder, K. Exel, and A. Meyer | | | | | | | | | | | |
| | | "Direct Bond Copper Substrates," from Thermalloy | | | | | | | | | | | |
| EXAMINER | | | | | | | | | DATE CONSIDERED | | | | |
| *EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant. | | | | | | | | | | | | | |

RECEIVED
SEP 12 2002
TECHNOLOGY CENTER R3700